



DATE: July 31, 2026

PCN #: 2845

PCN Title: Qualification of Additional Wafer Sources and Additional Assembly and Test Site for Select Discrete Products

Dear Customer:

This is an announcement of change(s) to products that are currently being offered by Diodes Incorporated.

We request that you acknowledge receipt of this notification within 30 days of the date of notification by contacting your local Diodes sales representative. If you require samples for evaluation purposes, please submit a corresponding request within 30 days as well. Otherwise, samples may not be built prior to the implementation of the announced change(s).

The change(s) announced in this PCN will not be implemented prior to the target implementation date, i.e. 90 days from the stated notification date, unless Diodes receives written customer approval before that date.

Previously agreed upon customer specific product and/or process change requirements will be addressed separately.

For questions or clarification regarding this PCN, please contact your local Diodes sales representative.

Sincerely,

Diodes Incorporated PCN Team



PRODUCT CHANGE NOTICE

PCN-2845-REV1

Notification Date:	Implementation Date:	Product Family:	Change Type:	PCN #:
July 31, 2026	October 30, 2026	Discrete Semiconductor	Additional Wafer Source / Additional Assembly and Test Site	2845
TITLE				
Qualification of Additional Wafer Sources and Additional Assembly and Test Site for Select Discrete Products				
DESCRIPTION OF CHANGE				
This PCN is being issued to notify customers that in order to assure continuity of supply, Diodes has qualified internal wafer fabrication sources JK FAB located in Hsinchu, Taiwan and GFAB located in Greenock, Scotland, and internal assembly and test (A/T) site WX2 located in WuXi, China as additional manufacturing sites for select discrete products listed below. Some products listed in Table 2 below also change bond wire from Au to PdCu and wire diameter. In addition, Diodes external wafer fab Shandong Jingdao Microelectronics Co., Ltd. (JDM) located in Shandong, China has qualified the manufacture of 6-inch diameter wafers in addition to the currently qualified 4-inch diameter wafers for select discrete products listed in Table 4 below. The package outline dimensions (POD) will be slightly different for products manufactured by WX2. Please refer to the details in Table 1 below. Full electrical characterization and high reliability testing has been completed on representative part numbers to ensure there is no change to device functionality or electrical specifications in the datasheet.				
IMPACT				
Continuity of Supply. No change in datasheet electrical parameters and product performance. There will be no change to form or function of products affected for the parts listed in Table 1. There will be no change to form, fit or function of products affected for the parts listed in Table 2-4.				
PRODUCTS AFFECTED				
Table 1 – Affected part list to qualify JK FAB as additional wafer source and WX2 as additional assembly and test site Table 2 – Affected part list to qualify JK FAB as additional wafer source Table 3 – Affected part list to qualify GFAB as additional wafer source Table 4 – Affected part list to qualify JDM 6-inch wafer as additional wafer source				
WEB LINKS				
Manufacturer’s Notice:	https://www.diodes.com/quality/product-change-notices/diodes-product-change-notices/			
For More Information Contact:	https://www.diodes.com/about/contact-us/contact-sales/			
Data Sheet:	https://www.diodes.com/catalog/			
DISCLAIMER				
Unless a Diodes Incorporated Sales representative is contacted in writing within 30 days from the notification date of this PCN, all changes described in this announcement are considered approved.				

